

End of Life Notification

End of Life Notification: EOL-000055 Date Issued: 10/20/2013

Dear Semtech Customer or Distributor:

This letter is to notify your company that Semtech is discontinuing the manufacture of the EClamp2357N.TCT products. In accordance with Semtech's product discontinuation policy, we are hereby giving notice of product discontinuance as a result of our suppliers inability to obtain sufficient material for continued manufacturing.

Semtech suggests the following replacement device: EClamp2357NQTCT. Product Data Sheet has been attached to this EOL notice.

Last Time Buy Conditions

As a result of our suppliers' inability to manufacture this product, Semtech Corporation is unable to offer any last time buy instructions.

LIMITED WARRANTY

In general, all discontinued product orders subject to this notice shall carry Semtech's standard limited warranty; or, if applicable, the warranty set forth in a duly executed formal contract between Semtech and your company will apply; except that:

- Semtech will accept all valid warranty claims for credit only, unless a replacement order is otherwise agreed upon by Semtech and the replacement parts can be manufactured or delivered from remaining inventory.
- 2. The applicable warranty period for making any return claims for discontinued products will be no later than ninety (90) days following delivery of the discontinued products.
- 3. Any return claims must be made under Semtech's current Return Material Authorization "RMA" procedures.

ADDITIONAL PROVISIONS

SEMTECH ACCEPTS NO LIABILITY FOR EXCESS REPROCUREMENT COSTS OR FOR ANY SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES WHATSOEVER ASSOCIATED WITH THIS NOTICE, WITH ITS PRODUCTS, OR WITH THE FINAL MANUFACTURE AND PERFORMANCE AGAINST ANY LAST TIME BUY ORDERS RELATED TO THE DISCONTINUED PRODUCTS COVERED BY THIS NOTICE.

We regret the inconvenience and impact this notice may cause your company. Semtech's sales, marketing, and distribution personnel stand ready to assist you in placing your company's orders for replacement product, or in providing the product information you require.

For product inquiries or purchase order information, please contact your local Semtech sales representative.



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EClamp2357NQ EMI Filter and ESD Protection for Secure Digital Card Interfaces

PROTECTION PRODUCTS - EMIClamp®

Description

The EClamp®2357NQ is a low pass filter array with integrated TVS diodes. It is designed to suppress unwanted EMI/RFI signals and provide electrostatic discharge (ESD) protection in portable electronic equipment. They have been optimized for protection of touch screen displays, secure digital (SD) card interfaces, and color LCD panels in cellular phones and other portable electronics.

The device consists of six pi filter circuits comprised of TVS diodes for ESD protection, and a resistor capacitor network for EMI/RFI filtering. A series resistor value of 100Ω and a component capacitance value of 10pF are used to achieve 20dB minimum attenuation from 1.0GHz to 3GHz. The device also includes 4 discrete TVS diodes for dedicated ESD protection. All of the TVS diodes provide effective suppression of ESD voltages in excess of ± 15 kV (air discharge) and ± 8 kV (contact discharge) per IEC 61000-4-2, level 4.

The EClamp2357NQ is qualified to AEC-Q100 Grade 1 for Automotive use.

Features

- ◆ EMI/RFI filter with integrated ESD protection
- ◆ ESD protection to IEC 61000-4-2 (ESD) Level4, ±15kV (air), ±8kV (contact)
- ◆ Filter performance: >30dB attenuation at 1.8GHz
- TVS working voltage: 5V
- lacktriangle Resistor: $100\Omega + /- 15\%$
- ◆ Component Capacitance: 10pF (VR = 0V)
- ◆ EMI & ESD protection for six lines
- Dedicated ESD protection for four lines
- Solid-state technology
- ◆ AEC-Q100 Grade 1 Qualified.

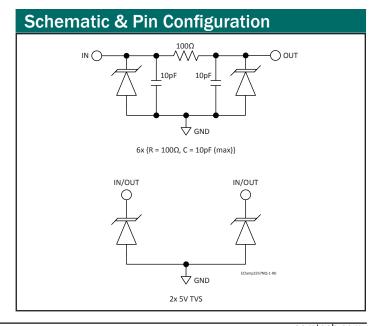
Mechanical Characteristics

- ♦ 16 pin QFN
- ◆ RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 3.0 x 3.0 x 1.0 mm
- ◆ Lead Pitch: 0.5mm
- Lead Finish: Matte Tin
- Marking: Marking Code
- Packaging: Tape and Reel per EIA 481

Applications

- Touch Screen Display Interfaces
- Secure Digital (SD) Memory Card Interfaces
- Multimedia Card Interfaces (MCI)
- Color LCD Panel Protection
- Cell Phone Handsets and Accessories
- Automotive Applications.

Package Dimensions 3.00 0.30 0.50 EClamp2357NQ-2-R1 16 Pin QFN (Top Side View) Nominal Dimensions (in mm)





Absolute Maximum Ratings

Rating	Symbol	Value	Units
ESD per IEC61000-4-2 (Air) ESD per IEC61000-4-2 (Contact)	V _{ESD}	±20 ±12	kV
Junction Temperature	T,	125	°C
Operating Temperature	T _{OP}	-40 to +125	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C unless otherwise specified)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
TVS Reverse Stand-Off Voltage	$V_{_{\mathrm{RWM}}}$					5	V
TVS Reverse Breakdown Voltage	$V_{_{\mathrm{BR}}}$	It =1mA T = -40 to +125°C		6	8	10	V
TVS Reverse Leakage Current	l _R	VRWM = 3.3V T = -40 to +125°C				0.5	μΑ
Total Series Resistance	R	Each Line T = -40 to +125°C		85	100	115	Ω
Total Canasitanas	C _{IN}	Input to Gnd Each Line f = 1MHz	VR = OV		20	22	pF
Total Capacitance			VR = 2.5V		12	15	



Typical Characteristics

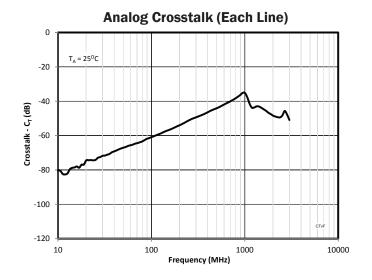
-40

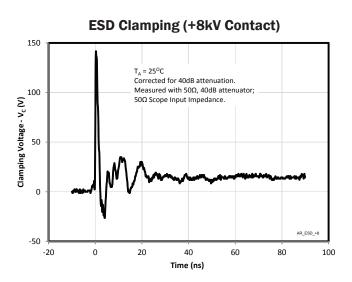
-50

Typical Insertion Loss S21 (Each Filter) T_A = 25°C Filter Input to Output T_A = 30°C Filter Input to Output

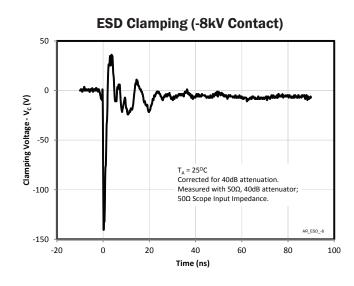
Frequency (MHz)

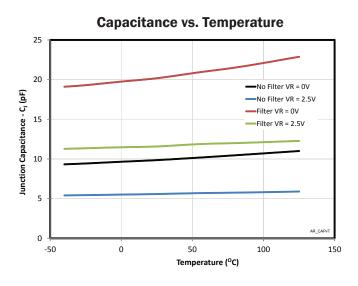
10000

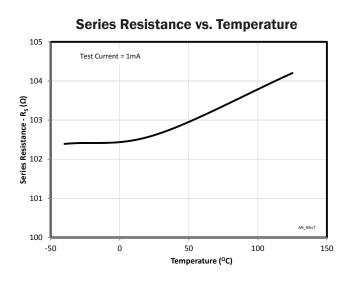




100



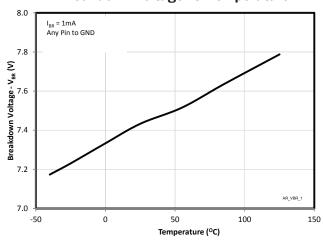




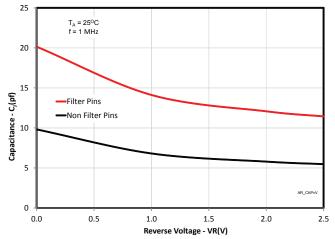


Typical Characteristics (Continued)

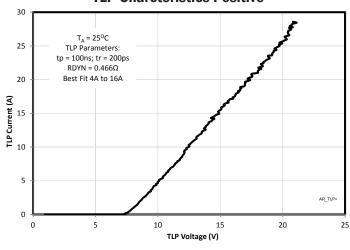
Breakdown Voltage vs. Temperature



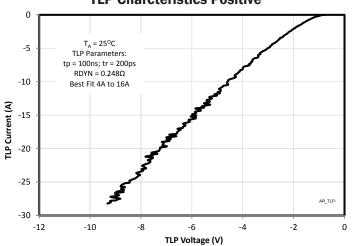
Capacitance vs. Reverse Voltage



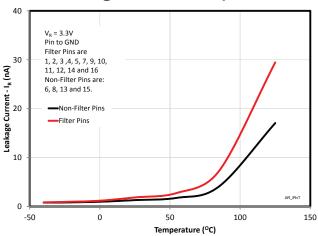
TLP Charcteristics Positive



TLP Charcteristics Positive



Leakage Current vs. Temperature





Applications Information

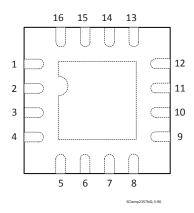
Device Connection

The EClamp2357NQ is comprised of six circuits each consisting of a low pass filter for EMI/RFI suppression and dual TVS diodes for ESD protection. It also includes 4 lines of TVS diodes for ESD protection of power lines or high speed I/O lines. The device is housed in a 16-pin Quad Flat No-Lead (QFN) package. Electrical connection is made via 16 pins located at the bottom of the device. A center tab serves as the ground connection. Pin connections are noted in the table to the right. The device is designed for easy PCB routing as shown in the application examples. All path lengths should be kept as short as possible to minimize the effects of parasitic inductance in the board traces.

Matte Tin Lead Finish

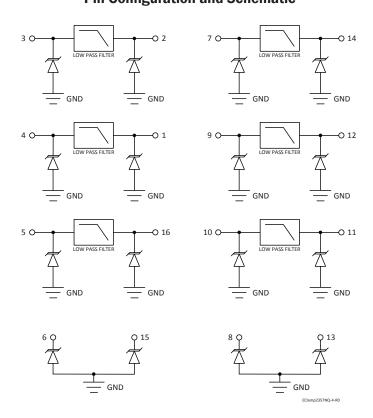
Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

Pin Identification and Configuration (Top Side View)



Pin	Identification
3, 4, 5, 7, 9, 10	Input EMI/ESD Protected Lines
1, 2, 11, 12, 14, 16	Output EMI/ESD Protected Lines
6, 8, 13, 15	Input/Output ESD Protected Lines
Center Tab	Ground

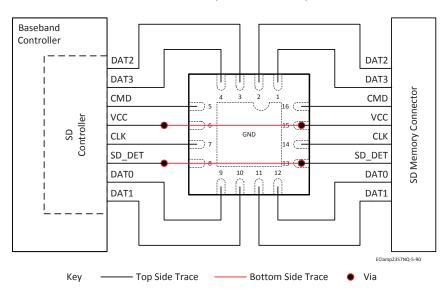
Pin Configuration and Schematic



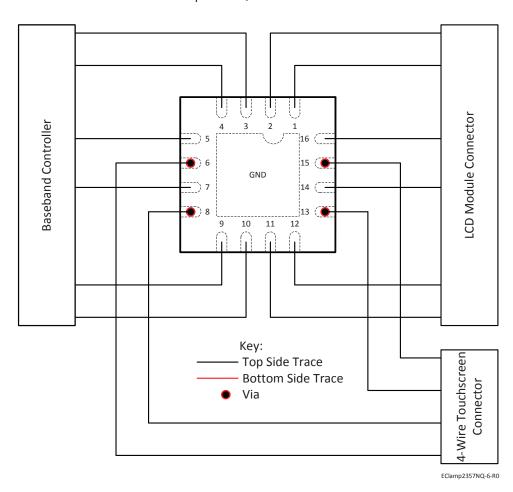


Applications Information

EClamp2357NQ SD Memory

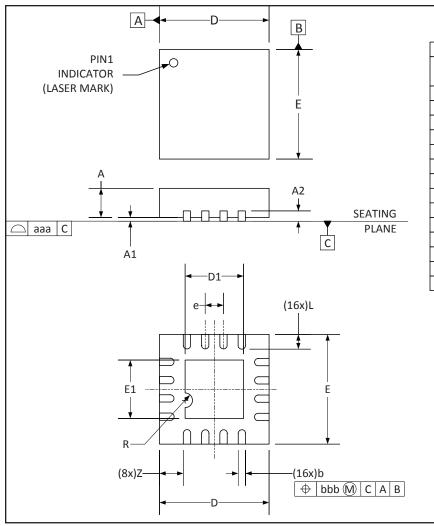


EClamp2357NQ LCD and Touch Pad





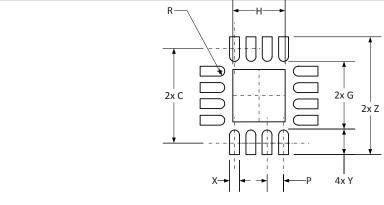
Outline Drawing - 16L QFN



DIMENSIONS						
DIM	INCHES			MILLIMETERS		
DIIVI	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.021	0.024	0.026	0.55	0.60	0.65
A1	0.000	0.001	0.002	0.00	0.02	0.05
A2	-	(0.006)	-	-	0.15	-
b	0.007	0.010	0.012	0.20	0.25	0.30
D	0.114	0.118	0.122	2.90	3.00	3.10
D1	0.055	0.059	0.063	1.40	1.50	1.60
Е	0.114	0.118	0.122	2.90	3.00	3.10
E1	0.055	0.059	0.063	1.40	1.50	1.60
е	-	0.020	-	-	0.50	-
L	0.014	0.016	0.018	0.35	0.40	0.45
R	-	0.008	-	-	0.20	-
Z	-	0.025	-	-	0.625	-
aaa		0.003		0.08		
bbb		0.004		0.10		

DR192540-2-R0

Land Pattern - 16L QFN



DIMENSIONS					
DIM	INCHES	MILLIMETERS			
С	(.114)	(2.90)			
G	.083	2.10			
Н	.063	1.60			
K	.063	1.60			
R	.006	0.15			
Р	.020	0.50			
Х	.012	0.30			
Υ	.031	0.80			
Z	.146	3.70			

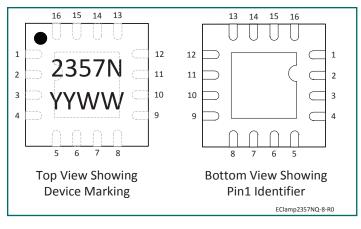
DR192540-3-R0

NOTES:

- 1: CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2: THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
- 3: THERMAL VIAS IN THE LAND PATTERN OF THE EXPOSED PAD SHALL BE CONNECTED TO A SYSTEM GROUND PLANE. FAILURE TO DO SO MAY COMPROMISE THE THERMAL AND/OR FUNCTIONAL PERFORMANCE OF THE DEVICE.



Marking



Ordering Information

Part Number	Qty per Reel	Reel Size
EClamp2357NQTCT	3000	7 Inch

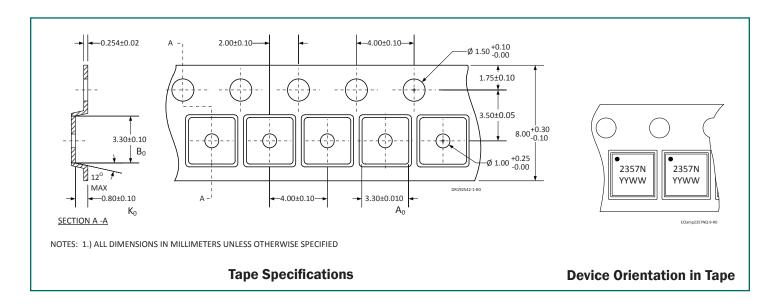
Note:

EClamp and EMIClamp are registered marks of Semtech Corporation.

Notes:

- 1) YYWW = Date Code
- 2) Pin 1 indicated by "Mouse Bite" on the ground pad

Tape and Reel Specification



Contact Information

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